# Beam test results of 3D pixel detectors constructed with pCVD diamond

Harris Kagan
Ohio State University
for the RD42 Collaboration

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#### Outline of Talk

- Introduction Motivation, RD42
- Diamond Detectors
- Results of 3D diamond pixel devices constructed with pCVD material
- Summary
- Future Plans

#### Introduction - Motivation



#### **Present Situation:**

- Innermost layers  $\rightarrow$  highest radiation damage (~100's MHz/cm<sup>2</sup>)
- Current detectors designed to survive ~12 months in HL- LHC
- → R&D for more radiation tolerant detector designs and/or materials

#### Diamond as a Detector Material:

• Properties:

radiation tolerance insulating material high charge carrier mobility smaller signal than in same thickness of silicon (larger bandgap)

#### RD42 work:

• Investigate signals and radiation tolerance in various detector designs:

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pad → full diamond as a single cell readout
pixel → diamond sensor on pixel chips
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#### Introduction - The 2018 RD42 Collaboration



#### The 2018 RD42 Collaboration

A. Alexopoulos<sup>3</sup>, M. Artuso<sup>20</sup>, F. Bachmair<sup>24</sup>, L. Bäni<sup>24</sup>, M. Bartosik<sup>3</sup>, J. Beacham<sup>13</sup>, H. Beck<sup>23</sup>, V. Bellini<sup>2</sup>, V. Belyaev<sup>12</sup>, B. Bentele<sup>19</sup>, P. Bergonzo<sup>11</sup>, A. Bes<sup>27</sup>, J-M. Brom<sup>7</sup>, M. Bruzzi<sup>4</sup>, G. Chiodini<sup>26</sup>, D. Chren<sup>18</sup>, V. Cindro<sup>9</sup>, G. Claus<sup>7</sup>, J. Collot<sup>27</sup>, J. Cumalat<sup>19</sup>, A. Dabrowski<sup>3</sup>, R. D'Alessandro<sup>4</sup>, D. Dauvergne<sup>27</sup>, W. de Boer<sup>10</sup>, S. Dick<sup>13</sup> C. Dorfer<sup>24</sup>, M. Dunser<sup>3</sup>, G. Eigen<sup>30</sup>, V. Eremin<sup>6</sup>, J. Forneris<sup>15</sup>, L. Gallin-Martel<sup>27</sup>, M.L. Gallin-Martel<sup>27</sup>, K.K. Gan<sup>13</sup>, M. Gastal<sup>3</sup>, C. Giroletti<sup>17</sup>, M. Goffe<sup>7</sup>, J. Goldstein<sup>17</sup>, A. Golubev<sup>8</sup>, A. Gorišek<sup>9</sup>, E. Grigoriev<sup>8</sup>, J. Grosse-Knetter<sup>23</sup>, A. Grummer<sup>21</sup>, M. Guthoff<sup>3</sup>, B. Hiti<sup>9</sup>, D. Hits<sup>24</sup>, M. Hoeferkamp<sup>21</sup>, T. Hofmann<sup>3</sup>, J. Hosslet<sup>7</sup>, J-Y. Hostachy<sup>27</sup>, F. Hügging<sup>1</sup>, C. Hutton<sup>17</sup>, J. Janssen<sup>1</sup>, H. Kagan<sup>13</sup>, K. Kanxheri<sup>28</sup>, G. Kasieczka<sup>24</sup>, R. Kass<sup>13</sup>, M. Kis<sup>5</sup>, G. Kramberger<sup>9</sup>, S. Kuleshov<sup>8</sup>, A. Lacoste<sup>27</sup>, S. Lagomarsino<sup>4</sup>, A. Lo Giudice<sup>15</sup>, E. Lukosi<sup>25</sup>, C. Maazouzi<sup>7</sup>, I. Mandic<sup>9</sup>, A. Marino<sup>19</sup>, C. Mathieu<sup>7</sup>, M. Menichelli<sup>28</sup>, M. Mikuž<sup>9</sup>, A. Morozzi<sup>28</sup>, J. Moss<sup>29</sup>, R. Mountain<sup>20</sup>, S. Murphy<sup>22</sup>, M. Muškinja<sup>9</sup>, A. Oh<sup>22</sup>, P. Olivero<sup>15</sup>, D. Passeri<sup>28</sup>, H. Pernegger<sup>3</sup>, R. Perrino<sup>26</sup>, F. Picollo<sup>15</sup>, M. Pomorski<sup>11</sup>, R. Potenza<sup>2</sup>, A. Quadt<sup>23</sup>, F. Rarbi<sup>27</sup>, A. Re<sup>15</sup>, M. Reichmann<sup>24</sup> G. Riley<sup>25</sup>, S. Roe<sup>3</sup>, D. Sanz<sup>24</sup>, M. Scaringella<sup>4</sup>, D. Schaefer<sup>3</sup>, C. Schmidt<sup>5</sup>, E. Schioppa<sup>3</sup>, S. Schnetzer<sup>14</sup>, S. Sciortino<sup>4</sup>, A. Scorzoni<sup>28</sup>, S. Seidel<sup>21</sup>, L. Servoli<sup>28</sup>, D.S. Smith<sup>13</sup>, B. Sopko<sup>18</sup>, V. Sopko<sup>18</sup>, S. Spagnolo<sup>26</sup>, S. Spanier<sup>25</sup>, K. Stenson<sup>19</sup>, R. Stone<sup>14</sup>, B. Stugu<sup>30</sup>, C. Sutera<sup>2</sup>, M. Traeger<sup>5</sup>, D. Tromson<sup>11</sup>, W. Trischuk<sup>16</sup>, C. Tuve<sup>2</sup>, J. Velthuis<sup>17</sup>, N. Venturi<sup>3</sup>, E. Vittone<sup>15</sup>, S. Wagner<sup>19</sup>, R. Wallny<sup>24</sup>, J.C. Wang<sup>20</sup>, J. Weingarten<sup>23</sup>, C. Weiss<sup>3</sup>, N. Wermes<sup>1</sup>, M. Yamouni<sup>27</sup>, J. Zalieckas<sup>30</sup>, M. Zavrtanik<sup>9</sup>

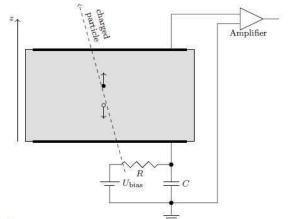
<sup>1</sup> Universität Bonn, Bonn, Germany <sup>2</sup> INFN/University of Catania, Catania, Italy 3 CERN, Geneva, Switzerland <sup>4</sup> INFN/University of Florence, Florence, Italy <sup>5</sup> GSI, Darmstadt, Germany <sup>6</sup> Ioffe Institute, St. Petersburg, Russia <sup>7</sup> IPHC, Strasbourg, France 8 ITEP, Moscow, Russia <sup>9</sup> Jožef Stefan Institute, Ljubljana, Slovenia <sup>10</sup> Universität Karlsruhe, Karlsruhe, Germany <sup>11</sup> CEA-LIST Technologies Avancees, Saclay, France <sup>12</sup> MEPHI Institute, Moscow, Russia <sup>13</sup> The Ohio State University, Columbus, OH, USA <sup>14</sup> Rutgers University, Piscataway, NJ, USA <sup>15</sup> University of Torino, Torino, Italy <sup>16</sup> University of Toronto, Toronto, ON, Canada <sup>17</sup> University of Bristol, Bristol, UK <sup>18</sup> Czech Technical University, Prague, Czech Republic <sup>19</sup> University of Colorado, Boulder, CO, USA <sup>20</sup> Syracuse University, Syracuse, NY, USA <sup>21</sup> University of New Mexico, Albuquerque, NM, USA <sup>22</sup> University of Manchester, Manchester, UK <sup>23</sup> Universität Goettingen, Goettingen, Germany <sup>24</sup> ETH Zürich, Zürich, Switzerland <sup>25</sup> University of Tennessee, Knoxville, TN, USA <sup>26</sup> INFN-Lecce, Lecce, Italy <sup>27</sup> LPSC-Grenoble, Grenoble, Switzerland <sup>28</sup> INFN-Perugia, Perugia, Italy <sup>29</sup> California State University - Sacramento, CA, USA 30 University of Bergen, Bergen, Norway

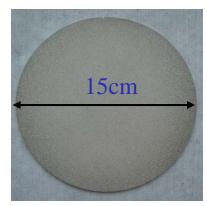
30 institutes

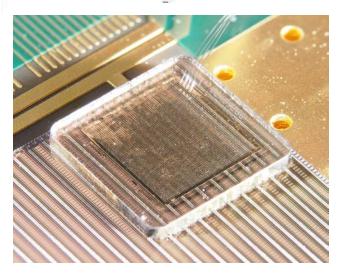
#### Introduction - Diamond as a Particle Detector



- Diamond detectors are operated as ionization chambers
- Poly-crystalline material comes in large wafers
- Metalization on both sides
  - Pad
  - Strip
  - Pixel (this talk)
- Connected (bump-bonded)
   to low noise electronics







pCVD diamond with 3D pixel device bump-bonded to FE-I4

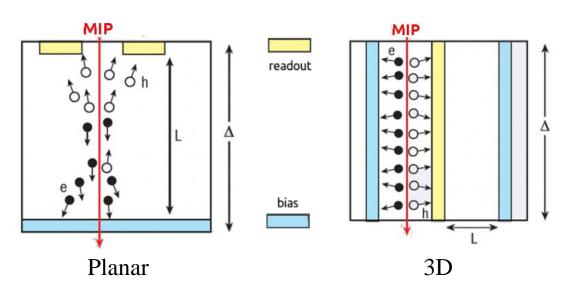


After large radiation fluence all detectors are trap limited

- •Mean free paths  $\lambda$  < 50µm
- •Need to keep drift distances (L) smaller than mfp ( $\lambda$ )

Comparison of planar and 3D devices

Can one do this in pCVD diamond?



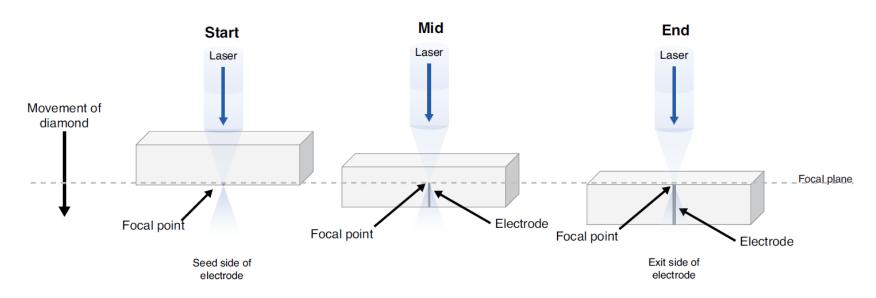
Have to make resistive columns in diamond for this to work

- -columns made with 800nm femtosecond laser
- -initial cells 150µm x 150µm; columns 6µm diameter



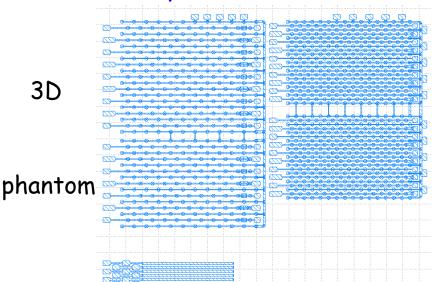
Femtosecond laser converts insulating diamond into resistive mixture of various carbon phases: amorphous carbon, DLC, nano-diamond, graphite.

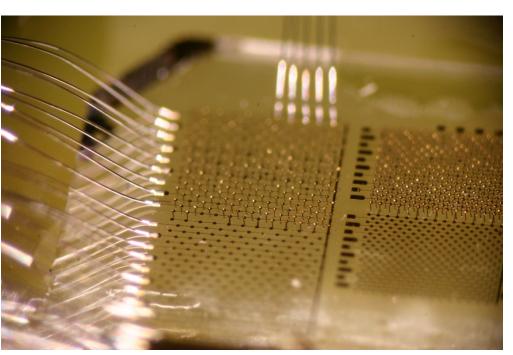
- Initial methods had 90% column yield → now >99% yield with Spatial Light Modulation (SLM)
- Initial column diameters 6-10 $\mu$ m  $\rightarrow$  now 2.6 $\mu$ m (with SLM)





#### Simultaneously readout all 3 devices





Three years ago we showed the results in scCVD diamond

-Compared scCVD strip detector (500V) with 3D (25V)

Two years ago the first 3D device in pCVD diamond

-Compare pCVD strip detector (500V) with 3D (60V)

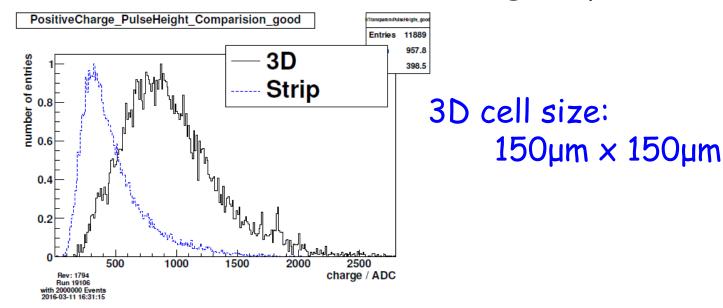
Last year the first 3D pixel detectors in pCVD diamond

This year 50µmx50µm 3D cells read out w/ATLAS, CMS electronics

strip

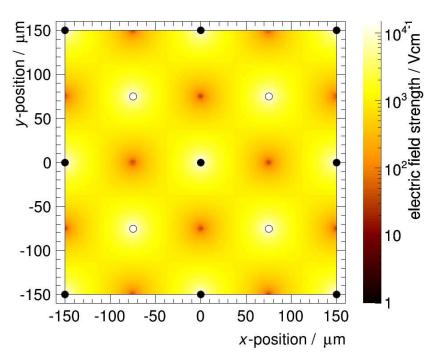


- Measured signal (diamond thickness 500µm):
  - Planar Strip ave charge
     6,900e or ccd=192µm
  - 3D ave charge 13,500e or  $ccd_{eq}=350-375\mu m$
- For the first time collect >75% of charge in pCVD





- Measurements consistent with TCAD simulations:
  - Large cells, large diameter columns → lower field regions in saddle points



Cell size: 150µm x 150µm

Voltage: 25V

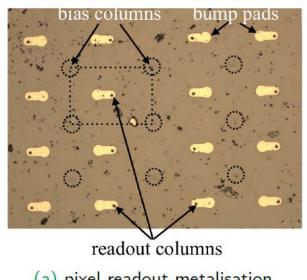
from: G. Forcolin, Ph.D. Thesis Manchester University 2017

Device worked well enough to construct first pCVD 3D diamond pixel device

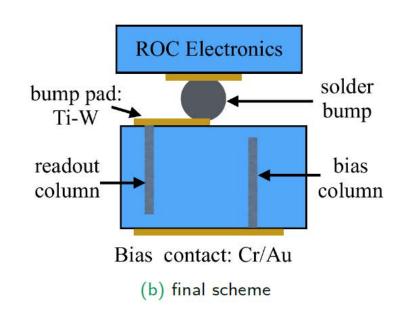


#### First 3D pixel device in pCVD (2017) - [150 $\mu$ m x 100 $\mu$ m cells]

- Produced cells with 150 $\mu$ m  $\times$  100 $\mu$ m size for CMS pixel readout chip
- Cleaning, photolithography, metal contact to pixel and bias RD42
- Bump and wire bonding Princeton

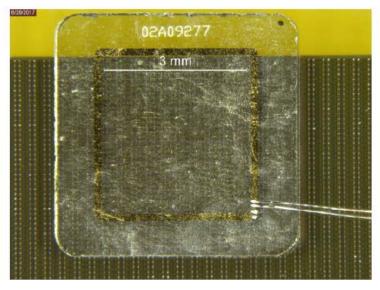


(a) pixel readout metalisation

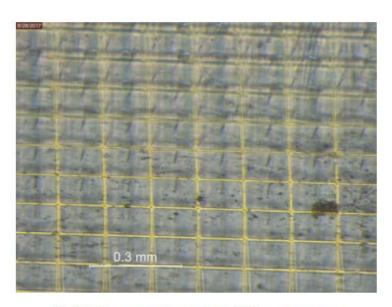




#### First 3D pixel device in pCVD (2017) - [150 $\mu$ m x 100 $\mu$ m cells]



(a) detector bonded on CMS-Pixel-Chip



(b) bias grid and R/O columns

successful production of a working 3D pixel detector

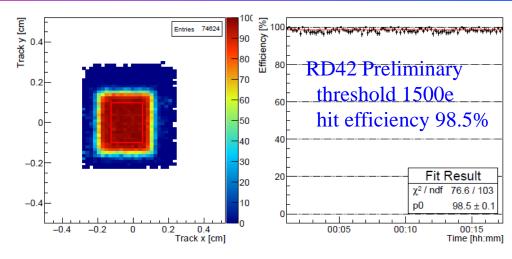


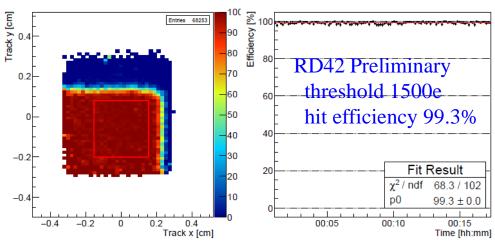
## 3D Diamond Pixel 98.5% efficiency

- applied voltage: -55V
- pixel threshold: 1500e
- efficiencies flat in time

## Planar Silicon Pixel (ref) 99.3% efficiency

 lower efficiency in diamond most likely due to low field regions



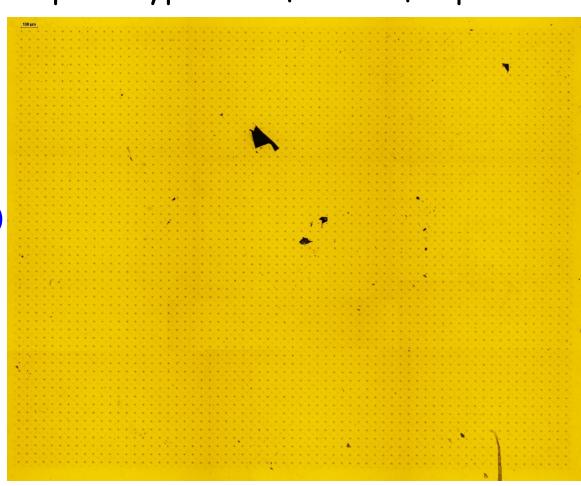


- (a) efficiency maps
- (b) hit efficiencies



#### Produced ~3500 cell pixel prototype w/50µm x 50µm pitch

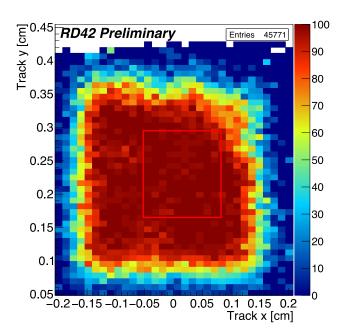
- Three fabricated:
  - Oxford 2; Manchester 1
- Photolith, Metalization
  - CMS, ATLAS
- 50μm × 50μm ganging
  - CMS (3x2),ATLAS (1x5)
- Bump bonding
  - CMS @Princeton
  - · ATLAS @IFAE
- Test beam
  - (3x2) Aug 2017 @PSI
  - (3x2) Oct 2018 @CERN
  - (1x5) Oct 2018 @CERN

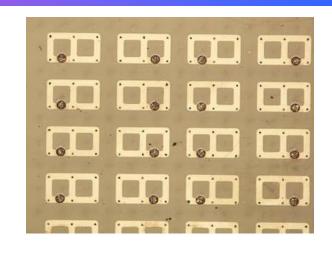


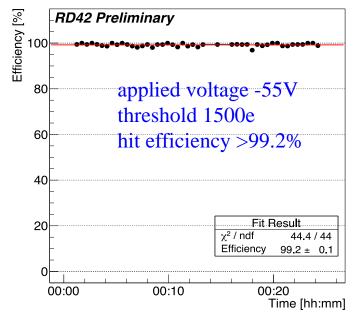


#### Preliminary Results (50µmx50µm cells)

- Readout with CMS pixel readout
   6 cells (3x2) ganged together
- Preliminary efficiency >99.2%
- Collect >80% of charge!









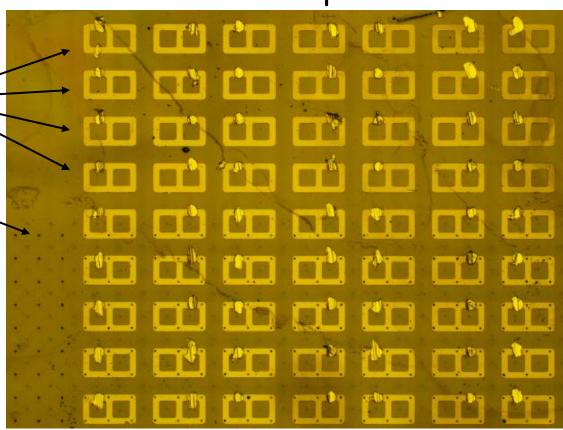
Preliminary Results (50µm×50µm cells) - 2×3 ganged cells

Readout with CMS pixel readout - hit efficiency >99.2%
 Photo after chip removal

No columns here

Extra columns here

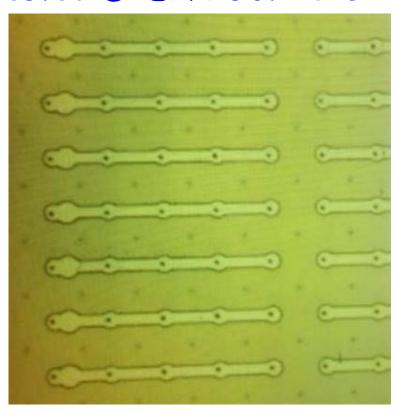
Some efficiency loss may be explained by mismatch between mask and column production





#### 50µm × 50µm 3D diamond with ATLAS pixel readout

- Readout w/FE-I4 pixel chip 5 cells (1x5) ganged
- Tested @CERN Oct 2018

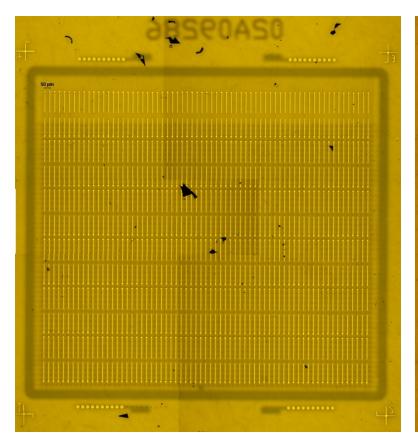


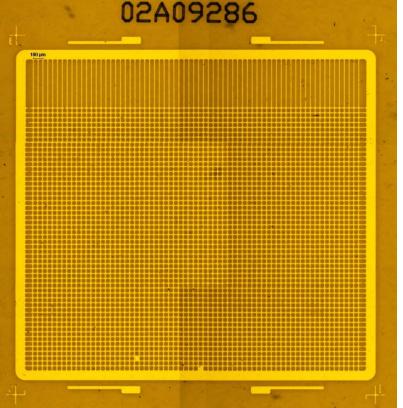




#### 50µm × 50µm 3D diamond with ATLAS pixel readout

- Readout w/FE-I4 pixel chip 5 cells (1x5) ganged
- · Another mismatch in mask this time

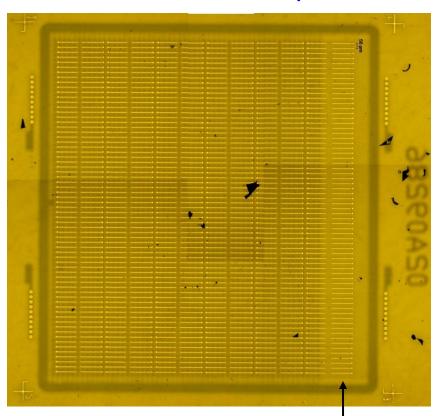


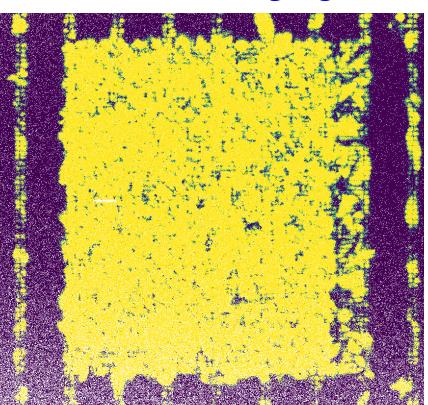




#### 50μm x 50μm 3D diamond with ATLAS pixels

Results w/FE-I4 pixel readout - 5 cells (1x5) ganged





Missing Columns

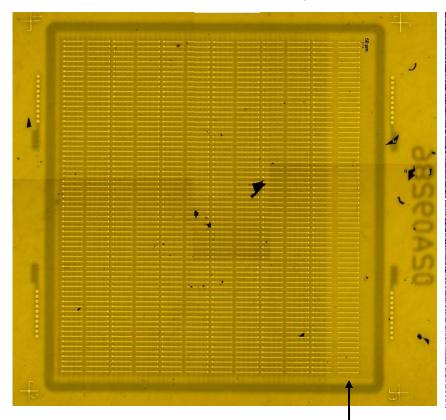
HV=-30V; Efficiency >93.5%

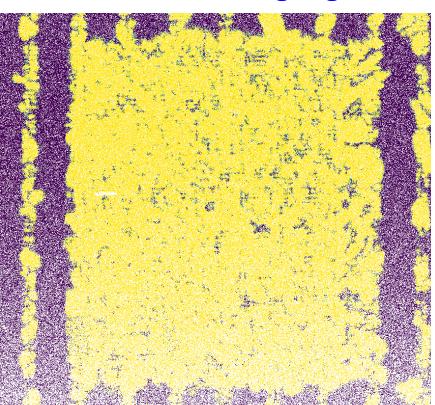
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#### 50μm x 50μm 3D diamond with ATLAS pixels

Results w/FE-I4 pixel readout - 5 cells (1x5) ganged





Missing Columns

HV=-70V; Efficiency >95%

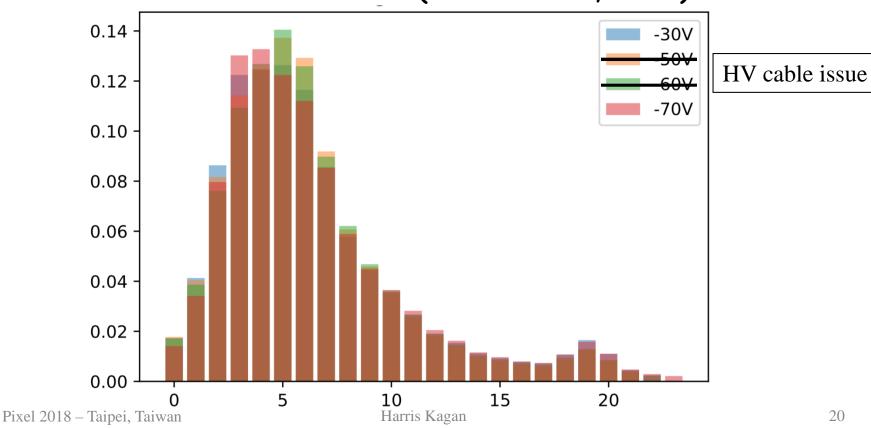
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## 5

#### 50µm x 50µm 3D diamond with ATLAS pixels

Results w/FE-I4 pixel readout - 5 cells (1x5) ganged

#### TOT Distribution (5 TOT ~ 11,000e)



### Summary



## Lots of progress in 3D diamond

- ■3D detector prototypes made great progress
  - 3D works in pCVD diamond
  - Scale up (x40) worked
  - Smaller cells (50μm x 50μm) worked
  - Thinner columns (2.6µm) worked
- ■3D diamond pixel devices being produced
  - Steps from  $150\mu m \times 100\mu m$  to  $50\mu m \times 50\mu m$
  - Visible improvements with each step
  - Efficiencies look good, still a bit to be understood
  - All work, to first order, as expected
  - More test beam results expected soon

#### Future Plans



#### Presented to LHCC w/HL-LHC in view

- ■3D diamond detector irradiations to 10<sup>17</sup> hadrons/cm<sup>2</sup>
  - Just tested 50μm × 50μm cells irradiated @3.5×10<sup>15</sup>p/cm<sup>2</sup>
  - Continue irradiation to 10<sup>16</sup>/cm<sup>2</sup> this coming year
  - Test both ( $50\mu m \times 50\mu m$ ) and ( $25\mu m \times 25\mu m$ ) pixel detectors
  - Thinner columns may be needed-try 2.0μm for 25μm x 25μm cells
  - Irradiation to 10<sup>17</sup>/cm<sup>2</sup> next year
- ■3D diamond pixel devices
  - Ready for RD53A chip readout this coming year
  - Continue scale up (x10)
  - Continue smaller cells (25µm x 25µm)

#### Acknowledgements



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